TE Internal #: 88976-5

FFC Contacts, Cable-to-Cable, 2.54 mm [.1 in] Centerline, FFC, Pin,

Gold Flash over Palladium Nickel / Gold, Reel, Insulation

Displacement (IDC)

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Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > FFC Contacts >

2.54mm FFC Connectors Pin Contacts











Connector System: Cable-to-Cable
Centerline (Pitch): 2.54 mm [.1 in]

Compatible With Wire & Cable Type: FFC

Contact Type: Pin

Contact Mating Area Plating Material: Gold, Gold Flash over Palladium Nickel

All 2.54mm FFC Connectors Pin Contacts (34)

Features

Product Type Features

Connector System	Cable-to-Cable
Sealable	No
Connector & Contact Terminates To	Wire & Cable
Configuration Features	
Compatible With Wire & Cable Type	FFC
Contact Features	
	15 uin

Contact reatures	
	15 μin
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Gold Flash
Contact Base Material	Phosphor Bronze
Contact Type	Pin
Contact Mating Area Plating Material	Gold, Gold Flash over Palladium Nickel



Contact Current Rating (Max)	2 A
Termination Features	
Termination Method to Wire & Cable	Insulation Displacement (IDC)
Mechanical Attachment	
Connector Mounting Type	Cable Mount (Free-Hanging)
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
Accepts Conductor Width	1.27 mm[.05 in]
Usage Conditions	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Circuit Application	Signal
Packaging Features	
Packaging Method	Reel
Other	
Comment	For use without housing.

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer



This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





Documents

Product Drawings

CONTACT,PIN,15AU,FFC

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_88976-5_AN.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_88976-5_AN.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_88976-5_AN.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

Product Specifications

Application Specification

English